

**HIGH SPEED 12V SYNCHRONOUS MOSFET DRIVER**

PRELIMINARY DATA SHEET

**Pb Free Product****DESCRIPTION**

The NX3202 is a high frequency MOSFET driver designed to drive two N-Channel MOSFETs in a synchronous rectified Step Down(BUCK) regulator topology. This driver combined with other NEXSEM controllers such as NX2511 or NX2517 2 to 4 phase controller ICs makes a high efficiency high performance Multiphase regulator designed for latest Microprocessor Vcore power as well as other high current regulator applications. The IC is powered by a single 12V supply and its low resistance drivers minimizes switching losses for high frequency applications using high gate capacitance MOSFETs. The NX3202 features 0.8 ohm sink resistance for the lower gate driver capable of holding the lower MOSFET gate off during SW node fast dv/dt rise time, preventing shoot through power loss.

**FEATURES**

- Bus voltage operation from 4V to 26V
- 12V High side and Low side drive capability
- High Peak Current Drive Capability
- High Frequency Operating Range
- Minimal Propagation Delay
- Non-overlap Adaptive Control
- Output disable(ODB) signal turns both outputs off
- Pb-free and RoHS compliant

**APPLICATIONS**

- Desktop and Notebook Microprocessor Vcore regulator applications
- High Current Multiphase Converter
- High Efficiency / High Current Graphic Vcore

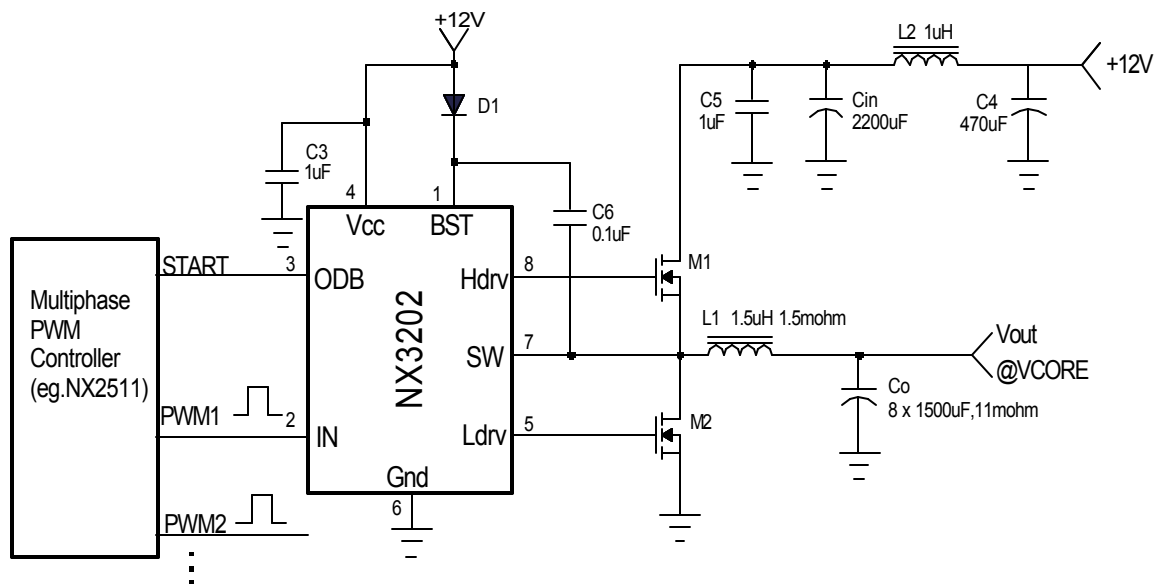
**TYPICAL APPLICATION**

Figure1 - Typical application of NX3202

**ORDERING INFORMATION**

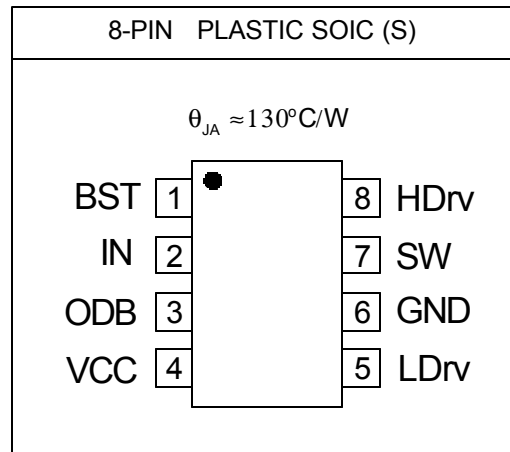
| Device     | Temperature | Package | Pb-Free |
|------------|-------------|---------|---------|
| NX3202CSTR | 0 to 70°C   | SOIC-8L | Yes     |

## ABSOLUTE MAXIMUM RATINGS

|  |                |
|--|----------------|
| Vcc to GND & BST to SW Voltage .....       | 16V            |
| BST to GND Voltage .....                   | 35V            |
| SW to GND Voltage .....                    | 35V            |
| ODB & IN to GND Voltage .....              | 16V            |
| Storage Temperature Range .....            | -65°C to 150°C |
| Operating Junction Temperature Range ..... | -40°C to 125°C |

Caution: Stresses above those listed in "ABSOLUTE MAXIMUM RATINGS", may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

## PACKAGE INFORMATION



## ELECTRICAL SPECIFICATIONS

Unless otherwise specified, these specifications apply over VCC =BST= 12V, SW=GND=0V, ODB=VCC, and T<sub>A</sub> = 0 to 125°C. Typical values refer to T<sub>A</sub> = 25°C.

| PARAMETERS                           | SYM       | TEST CONDITIONS                   | MIN | TYP | MAX | UNITS |
|--------------------------------------|-----------|-----------------------------------|-----|-----|-----|-------|
| <b>Vcc Supply</b>                    |           |                                   |     |     |     |       |
| Under Volatge Lockout, VCC Supply    | UVLO, Vcc | Vcc ramping up                    |     | 3   |     | V     |
| Vcc Quiescent Current Operating Mode | Iq        | VBST=12V, IN=0V                   |     | 1.6 |     | mA    |
|                                      |           | IN=Swch at 500Khz, 50% DC, CL=0   |     | 3.2 |     |       |
|                                      |           | IN=Swch at 200Khz, 50% DC, CL=3nF |     | 17  |     |       |
| Vcc Quiescent Current Shutdown Mode  | Iqsd      | ODB=0V<br>IN=0V                   |     | 1.2 |     | mA    |
| <b>ODB</b>                           |           |                                   |     |     |     |       |
| ODB Threshold (High)                 | ODB(H)    |                                   | 2.4 |     |     | V     |
| ODB Threshold (Low)                  | ODB(L)    |                                   |     |     | 0.8 | V     |
| ODB Current                          | Ienb      |                                   | -2  |     | 2   | uA    |
| Propagation delay time               | Tprop     |                                   |     | 15  |     | ns    |

| PARAMETERS                         | SYM                | TEST CONDITIONS                               | MIN | TYP | MAX | UNITS |
|------------------------------------|--------------------|---|-----|-----|-----|-------|
| <b>IN</b>                          |                    |   |     |     |     |       |
| Input voltage High                 | IN (H)             |   | 2.4 |     |     | V     |
| Input Voltage low                  | IN(L)              |   |     |     | 0.8 | V     |
| Input Current                      | $I_{bias-ODB}$     |   | -2  |     | 2   | uA    |
| <b>High Side driver(CL=3300pF)</b> |                    |   |     |     |     |       |
| Output Impedance, Sourcing Current | $R_{source}(Hdrv)$ | VBST-VSW=12V                                  |     | 1.7 |     | Ohm   |
| Output Impedance , Sinking Current | $R_{sink}(Hdrv)$   |   |     | 0.7 |     | Ohm   |
| Rise Time                          | THDrv(Rise)        |   |     | 40  |     | ns    |
| Fall Time                          | THDrv(Fall)        |   |     | 20  |     | ns    |
| Deadband Time                      | Tdead(L to H)      | LDRV going Low to HDrv going High, 10% to 10% |     | 75  |     | ns    |
| Propagation Delay                  | Tdelay(H)          | IN going HI to LDRV going Low                 |     | 55  |     | ns    |
| <b>Low Side Driver(CL=3300pF)</b>  |                    |   |     |     |     |       |
| Output Impedance, Sourcing Current | $R_{source}(Ldrv)$ |   |     | 1.7 |     | Ohm   |
| Output Impedance , Sinking Current | $R_{sink}(Ldrv)$   |   |     | 0.7 |     | Ohm   |
| Rise Time                          | TLDrv(Rise)        | 10% to 90%                                    |     | 40  |     | ns    |
| Fall Time                          | TLDrv(Fall)        | 90% to 10%                                    |     | 20  |     | ns    |
| Deadband Time                      | Tdead(H to L)      | SW going Low to LDRV going High, 10% to 10%   |     | 30  |     | ns    |
| Propagation Delay                  | Tdelay(L)          | IN going Low to LDRV going HI                 |     | 65  |     | ns    |

## PIN DESCRIPTIONS

| Pin# | Pin Symbol  | Pin Description   |
|------|-------------|---|
| 1    | <b>BST</b>  | Bootstrap Pin. A capacitor is connected between BST and SW pins to generate the floating bootstrap voltage for High-side Driver. The capacitor value is typically between 0.1uF to 1uF. |
| 2    | <b>IN</b>   | PWM input signal to the MOSFET drivers.   |
| 3    | <b>ODB</b>  | Output disable pin. When high the internal circuitry is enabled. When low both high side and low side drivers are turned off.   |
| 4    | <b>VCC</b>  | Biasing supply both for the IC and low side driver, a minimum of 1uF ceramic cap should be connected between this pin and PGND.   |
| 5    | <b>LDRV</b> | Output driver for low side MOSFET.  |
| 6    | <b>GND</b>  | Power ground.   |
| 7    | <b>SW</b>   | Switching point, this pin connects to the junction of external high-side and low-side MOSFETs.  |
| 8    | <b>HDRV</b> | Output drive for high-side MOSFET.  |

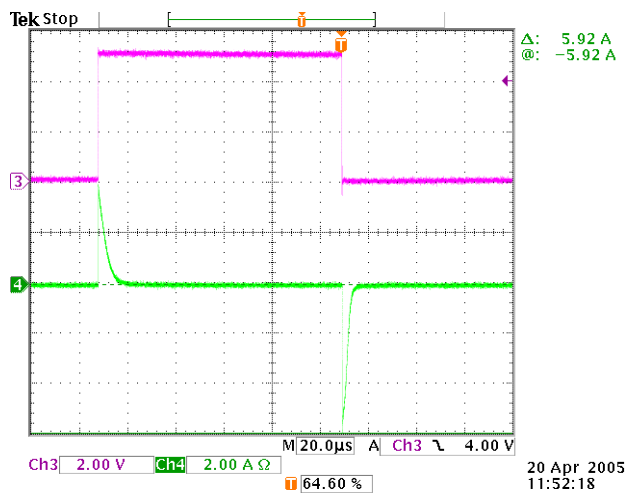


Figure 2 - Hdrv peak current

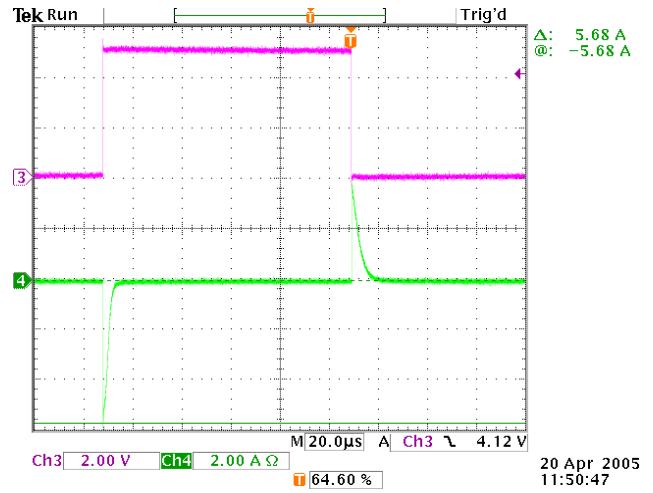


Figure 3 - Ldrv peak current